

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

David R. Hembree

Serial No.: 10/624,332

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For: CHIP ON BOARD AND HEAT SINK
ATTACHMENT METHODS

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**FEE ADDRESSEE FOR RECEIPT OF PTO NOTICES
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Mail Stop ISSUE FEE
Commissioner for Patents
P.O. Box 1450
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Sir:

1. This letter is to specify that the FEE ADDRESSEE for this patent is:

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2. The Customer Number for the Fee Addressee is **26809**.
3. Any prior FEE ADDRESSEE for this patent is hereby revoked.
4. It is certified that the person whose signature appears below has the authority to change the FEE ADDRESSEE for this patent.

Respectfully submitted,



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Date: May 16, 2007
JRD/dlm

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